

Certificate IATF 0561539
Certificate SG19/81841734

The management system of

Ardentec Singapore Pte Ltd

SGS

IATF USI: T99KNG
12 Woodlands Loop, #02-00, Singapore 738283

has been assessed and certified as meeting the requirements of

IATF 16949:2016

Edition 1

For the following Scope
Production of semiconductor device trimming

EXCLUSIONS: 8.3 Product Design

3 Year certification is valid from 08 January 2025 until 07 January 2028 and remains valid subject to satisfactory surveillance audits.

Version no. 4. Current version updated 08 January 2025



Authorised by
Gatot Hartanto
Veto Power Authority
Contracted Office : SGS United Kingdom Ltd, Station Road, Oldbury, B69 4LN, UK.
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SGS

Ardentec Singapore Pte Ltd

IATF 16949:2016

Edition 1

Additional facilities

Support Function

Ardentec Corporation

IATF USI: 3C2TFP

No. 24, Wenhua Rd., Hsin-Chu Industrial Park, Hukou Township, 30352 Hsinchu County, Taiwan

Summary of Activities

Sales



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